

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YASUYUKI SUKI	05/08/2014
<b>RECEIVING PARTY DATA</b>	
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<b>State/Country:</b>	JAPAN
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	29485625
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)955-3751
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<b>NAME OF SUBMITTER:</b>	JIYEON CHOI
<b>SIGNATURE:</b>	/Jiyeon Choi/
<b>DATE SIGNED:</b>	01/16/2015
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 2</b>	
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**DECLARATION AND ASSIGNMENT**

**DISPLAY PANEL OR SCREEN WITH GRAPHICAL USER INTERFACE**

As a below named inventor, I hereby declare that:

This declaration is directed to:

- the attached application, or  
 United States application or PCT international application  
number 29/485,625, filed on March 20, 2014.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a  
claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration  
is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years,  
or both.

I have reviewed and understand the contents of the above-identified  
application, including the claims.

I acknowledge the duty to disclose information which is material to  
patentability as defined in Title 37, Code of Federal Regulations § 1.56.

WHEREAS, the below named inventor(s) have invented certain new and  
useful improvements described in the above-identified application,

AND WHEREAS, **Sony Corporation, 1-7-1 Konan, Minato-ku, Tokyo, Japan**, a corporation of Japan (hereinafter referenced as ASSIGNEE), is desirous of  
acquiring all interest in, to and under the invention, the above-identified application  
disclosing the invention and in, to and under any Letters Patent or similar legal protection  
which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, for good and valuable consideration, the receipt and  
sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated  
below, have assigned, sold and transferred, and do hereby assign, sell and transfer unto the  
ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and  
interest in the invention and the above-identified application, including any divisions and  
continuations thereof, and in and to any and all Letters Patent of the United States, and  
countries foreign thereto, which may be granted for the invention, and in and to any all  
priority rights and/or convention rights under the International Convention for the Protection  
of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial  
Models, and any other international agreements to which the United States of America

adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

This assignment executed on the date(s) indicated below.

Yasuyuki SUKI  
Legal Name of Inventor

Yasuyuki Suki  
Signature of Inventor

Date May 8, 2014

Additional inventors are named on the supplemental sheet(s) attached hereto.